

MC74AC00, MC74ACT00

Quad 2-Input NAND Gate High-Performance Silicon-Gate CMOS



ON Semiconductor®

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Features

- Output Drive Capability: ± 24 mA
- Operating Voltage Range: 2 to 6 V AC00; 4.5 to 5.5 ACT00
- Low Input Current: $1.0 \mu\text{A}$
- High Noise Immunity Characteristic of CMOS Devices
- In Compliance With the JEDEC Standard No. 7A Requirements
- Chip Complexity: 32 FETs
- These are Pb-Free Devices

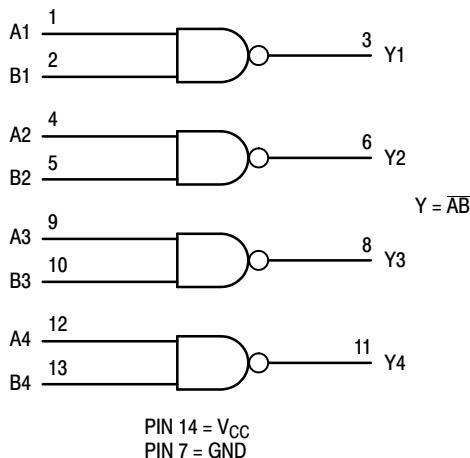


Figure 1. Logic Diagram

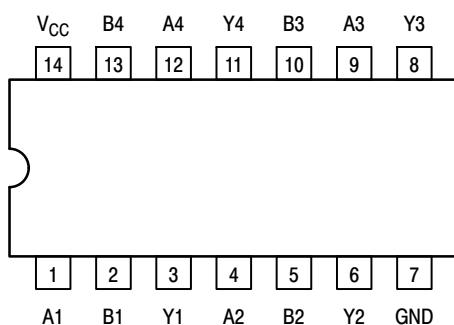
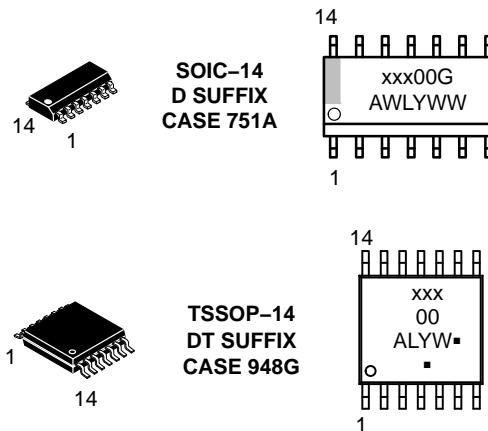


Figure 2. Pinout: 14-Lead Packages (Top View)

MARKING DIAGRAMS



xxx = AC or ACT
A = Assembly Location
WL or L = Wafer Lot
Y = Year
WW or W = Work Week
G or ▪ = Pb-Free Package

(Note: Microdot may be in either location)

FUNCTION TABLE

Inputs		Output
A	B	Y
L	L	H
L	H	H
H	L	H
H	H	L

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 5 of this data sheet.

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MAXIMUM RATINGS

Symbol	Parameter	Value	Unit	
V_{CC}	DC Supply Voltage	-0.5 to +7.0	V	
V_I	DC Input Voltage	$-0.5 \leq V_I \leq V_{CC} + 0.5$	V	
V_O	DC Output Voltage (Note 1)	$-0.5 \leq V_O \leq V_{CC} + 0.5$	V	
I_{IK}	DC Input Diode Current	± 20	mA	
I_{OK}	DC Output Diode Current	± 50	mA	
I_O	DC Output Sink/Source Current	± 50	mA	
I_{CC}	DC Supply Current per Output Pin	± 50	mA	
I_{GND}	DC Ground Current per Output Pin	± 50	mA	
T_{STG}	Storage Temperature Range	-65 to +150	°C	
T_L	Lead temperature, 1 mm from Case for 10 Seconds	260	°C	
T_J	Junction temperature under Bias	+150	°C	
θ_{JA}	Thermal Resistance (Note 2)	SOIC TSSOP 125 170	°C/W	
P_D	Power Dissipation in Still Air at 85°C	SOIC TSSOP 125 170	mW	
MSL	Moisture Sensitivity	Level 1		
F_R	Flammability Rating	Oxygen Index: 30% – 35%	UL 94 V-0 @ 0.125 in	
V_{ESD}	ESD Withstand Voltage	Human Body Model (Note 3) Machine Model (Note 4) Charged Device Model (Note 5)	> 2000 > 200 > 1000	V
$I_{Latch-Up}$	Latch-Up Performance Above V_{CC} and Below GND at 85°C (Note 6)	± 100	mA	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. I_O absolute maximum rating must be observed.
2. The package thermal impedance is calculated in accordance with JESD51-7.
3. Tested to EIA/JESD22-A114-A.
4. Tested to EIA/JESD22-A115-A.
5. Tested to JESD22-C101-A.
6. Tested to EIA/JESD78.

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Min	Typ	Max	Unit
V_{CC}	Supply Voltage MC74AC00 MC74ACT00	2.0 4.5	5.0 5.0	6.0 5.5	V
V_{in}, V_{out}	DC Input Voltage, Output Voltage (Ref. to GND)	0	-	V_{CC}	V
t_r, t_f	Input Rise and Fall Time (Note 7) MC74AC00	- - -	150 40 25	-	ns/V
t_r, t_f	Input Rise and Fall Time (Note 8) MC74ACT00	- -	10 8.0	-	ns/V
T_J	Junction Temperature	-	-	150	°C
T_A	Operating Ambient Temperature Range	-55	25	125	°C
I_{OH}	Output Current – High	-	-	-24	mA
I_{OL}	Output Current – Low	-	-	24	mA

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

7. V_{in} from 30% to 70% V_{CC} .
8. V_{in} from 0.8 V to 2.0 V.

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DC CHARACTERISTICS

Symbol	Parameter	V _{CC} (V)	MC74AC00					Unit	Conditions		
			T _A = +25°C		T _A = -40°C to +85°C		T _A = -55°C to +125°C				
			Typ	Guaranteed Limits							
V _{IH}	Minimum High Level Input Voltage	3.0 4.5 5.5	1.5 2.25 2.75	2.1 3.15 3.85	2.1 3.15 3.85	2.1 3.15 3.85	2.1 3.15 3.85	V	V _{OUT} = 0.1 V or V _{CC} - 0.1 V		
V _{IL}	Maximum Low Level Input Voltage	3.0 4.5 5.5	1.5 2.25 2.75	0.9 1.35 1.65	0.9 1.35 1.65	0.9 1.35 1.65	0.9 1.35 1.65	V	V _{OUT} = 0.1 V or V _{CC} - 0.1 V		
V _{OH}	Minimum High Level Output Voltage	3.0 4.5 5.5	2.99 4.49 5.49	2.9 4.4 5.4	2.9 4.4 5.4	2.9 4.4 5.4	2.9 4.4 5.4	V	I _{OUT} = -50 μA		
		3.0 4.5 5.5	- - -	2.56 3.86 4.86	2.46 3.76 4.76	2.4 3.7 4.7	2.4 3.7 4.7	V	*V _{IN} = V _{IL} or V _{IH} I _{OH} -12 mA -24 mA -24 mA		
V _{OL}	Maximum Low Level Output Voltage	3.0 4.5 5.5	0.002 0.001 0.001	0.1 0.1 0.1	0.1 0.1 0.1	0.1 0.1 0.1	0.1 0.1 0.1	V	I _{OUT} = 50 μA		
		3.0 4.5 5.5	- - -	0.36 0.36 0.36	0.44 0.44 0.44	0.5 0.5 0.5	0.5 0.5 0.5	V	*V _{IN} = V _{IL} or V _{IH} I _{OL} 12 mA 24 mA 24 mA		
I _{IN}	Maximum Input Leakage Current	5.5	-	± 0. 1	± 1.0	± 1.0	± 1.0	μA	V _I = V _{CC} , GND		
I _{OLD}	†Minimum Dynamic Output Current	5.5	-	-	75	50	mA	V _{OLD} = 1.65 V Max			
I _{OHD}		5.5	-	-	-75	-50	mA	V _{OHD} = 3.85 V Min			
I _{CC}	Maximum Quiescent Supply Current	5.5	-	4.0	40	40	μA	V _{IN} = V _{CC} or GND			

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

*All outputs loaded; thresholds on input associated with output under test.

†Maximum test duration 2.0 ms, one output loaded at a time.

NOTE: I_{IN} and I_{CC} @ 3.0 V are guaranteed to be less than or equal to the respective limit @ 5.5 V V_{CC}.

AC CHARACTERISTICS (t_r = t_f = 3.0 nS; C_L = 50 pF; see Figures 3 and 4 for Waveforms)

Symbol	Parameter	V _{CC} * (V)	MC74AC00							Unit	
			T _A = +25°C			T _A = -40°C to +85°C		T _A = -55°C to +125°C			
			Min	Typ	Max	Min	Max	Min	Max		
t _{PLH}	Propagation Delay	3.3 5.0	2.0 1.5	7.0 6.0	9.5 8.0	2.0 1.5	10.0 8.5	1.0 1.0	11.0 8.5	ns	
t _{PHL}	Propagation Delay	3.3 5.0	1.5 1.5	5.5 4.5	8.0 6.5	1.0 1.0	8.5 7.0	1.0 1.0	9.0 7.0	ns	

*Voltage Range 3.3 V is 3.3 V ± 0.3 V.

Voltage Range 5.0 V is 5.0 V ± 0.5 V.

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DC CHARACTERISTICS

Symbol	Parameter	V _{CC} (V)	MC74ACT00						Unit	Conditions		
			T _A = +25°C		T _A = -40°C to +85°C		T _A = -55°C to +125°C					
			Typ	Guaranteed Limits								
V _{IH}	Minimum High Level Input Voltage	4.5 5.5	1.5 1.5	2.0 2.0	2.0 2.0	2.0 2.0	2.0 2.0	2.0 2.0	V	V _{OUT} = 0.1 V or V _{CC} - 0.1 V		
V _{IL}	Maximum Low Level Input Voltage	4.5 5.5	1.5 1.5	0.8 0.8	0.8 0.8	0.8 0.8	0.8 0.8	0.8 0.8	V	V _{OUT} = 0.1 V or V _{CC} - 0.1 V		
V _{OH}	Minimum High Level Output Voltage	4.5 5.5	4.49 5.49	4.4 5.4	4.4 5.4	4.4 5.4	4.4 5.4	4.4 5.4	V	I _{OUT} = -50 μA		
		4.5 5.5	— —	3.86 4.86	3.76 4.76	3.7 4.7	3.7 4.7	3.7 4.7	V	*V _{IN} = V _{IL} or V _{IH} I _{OH} -24 mA -24 mA		
V _{OL}	Maximum Low Level Output Voltage	4.5 5.5	0.001 0.001	0.1 0.1	0.1 0.1	0.1 0.1	0.1 0.1	0.1 0.1	V	I _{OUT} = 50 μA		
		4.5 5.5	— —	0.36 0.36	0.44 0.44	0.44 0.44	0.5 0.5	0.5 0.5	V	*V _{IN} = V _{IL} or V _{IH} I _{OL} 24 mA 24 mA		
I _{IN}	Maximum Input Leakage Current	5.5	—	± 0.1	± 1.0	± 1.0	± 1.0	± 1.0	μA	V _I = V _{CC} , GND		
ΔI _{CCT}	Additional Max. I _{CC} /Input	5.5	0.6	—	1.5	1.5	1.6	1.6	mA	V _I = V _{CC} - 2.1 V		
I _{OLD}	†Minimum Dynamic Output Current	5.5	—	—	75	75	50	50	mA	V _{OLD} = 1.65 V Max		
		5.5	—	—	-75	-75	-50	-50	mA	V _{OHD} = 3.85 V Min		
I _{CC}	Maximum Quiescent Supply Current	5.5	—	4.0	40	40	40	40	μA	V _{IN} = V _{CC} or GND		

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

*All outputs loaded; thresholds on input associated with output under test.

†Maximum test duration 2.0 ms, one output loaded at a time.

AC CHARACTERISTICS (t_r = t_f = 3.0 nS; C_L = 50 pF; see Figures 3 and 4 for Waveforms)

Symbol	Parameter	V _{CC} * (V)	MC74ACT00								Unit	
			T _A = +25°C			T _A = -40°C to +85°C		T _A = -55°C to +125°C				
			Min	Typ	Max	Min	Max	Min	Max	ns		
t _{PLH}	Propagation Delay	5.0	1.5	5.5	9.0	1.0	9.5	1.0	9.5	ns		
t _{PHL}	Propagation Delay	5.0	1.5	4.0	7.0	1.0	8.0	1.0	8.0	ns		

*Voltage Range 5.0 V is 5.0 V ± 0.5 V.

CAPACITANCE

Symbol	Parameter	Value Typ	Test Conditions	Unit
C _{IN}	Input Capacitance	4.5	V _{CC} = 5.0 V	pF
C _{PD}	Power Dissipation Capacitance	30	V _{CC} = 5.0 V	pF

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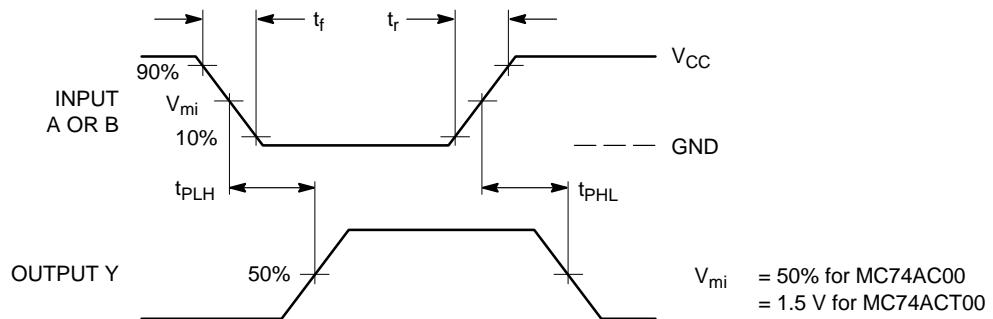
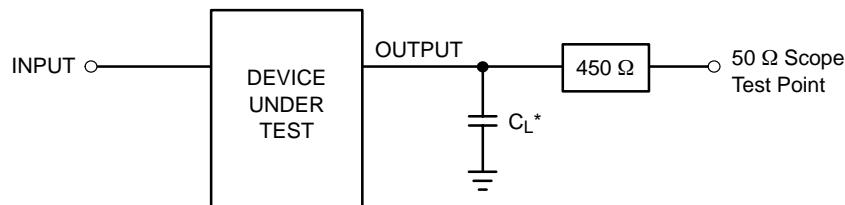


Figure 3. Switching Waveforms



*Includes all probe and jig capacitance

Figure 4. Test Circuit

ORDER INFORMATION

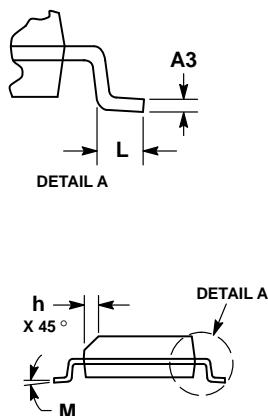
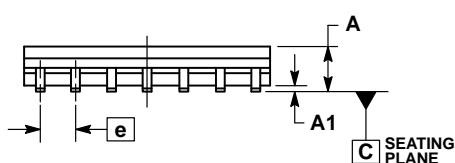
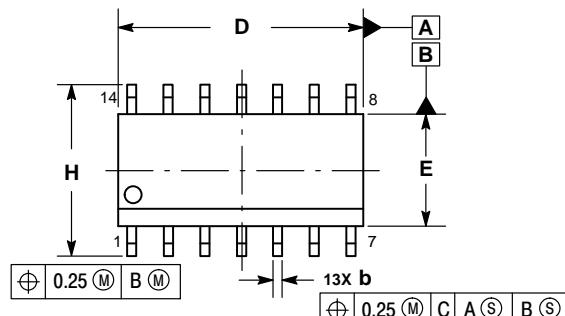
Device	Package	Shipping [†]
MC74AC00DG	SOIC-14 (Pb-Free)	55 Units / Rail
MC74AC00DR2G	SOIC-14 (Pb-Free)	2500 / Tape and Reel
MC74AC00DTR2G	TSSOP-14 (Pb-Free)	
MC74ACT00DG	SOIC-14 (Pb-Free)	55 Units / Rail
MC74ACT00DR2G	SOIC-14 (Pb-Free)	2500 / Tape and Reel
MC74ACT00DTR2G	TSSOP-14 (Pb-Free)	

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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PACKAGE DIMENSIONS

SOIC-14 NB
CASE 751A-03
ISSUE K

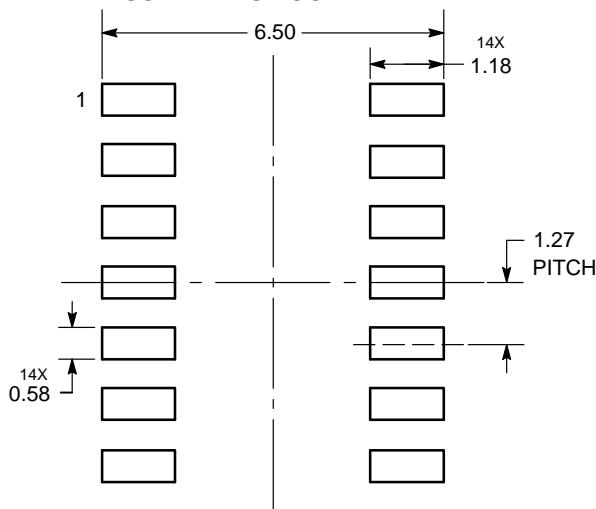


NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. DIMENSION b DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE PROTRUSION SHALL BE 0.13 TOTAL IN EXCESS OF AT MAXIMUM MATERIAL CONDITION.
4. DIMENSIONS D AND E DO NOT INCLUDE MOLD PROTRUSIONS.
5. MAXIMUM MOLD PROTRUSION 0.15 PER SIDE.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	1.35	1.75	0.054	0.068
A1	0.10	0.25	0.004	0.010
A3	0.19	0.25	0.008	0.010
b	0.35	0.49	0.014	0.019
D	8.55	8.75	0.337	0.344
E	3.80	4.00	0.150	0.157
e	1.27 BSC		0.050 BSC	
H	5.80	6.20	0.228	0.244
h	0.25	0.50	0.010	0.019
L	0.40	1.25	0.016	0.049
M	0 °	7 °	0 °	7 °

SOLDERING FOOTPRINT*



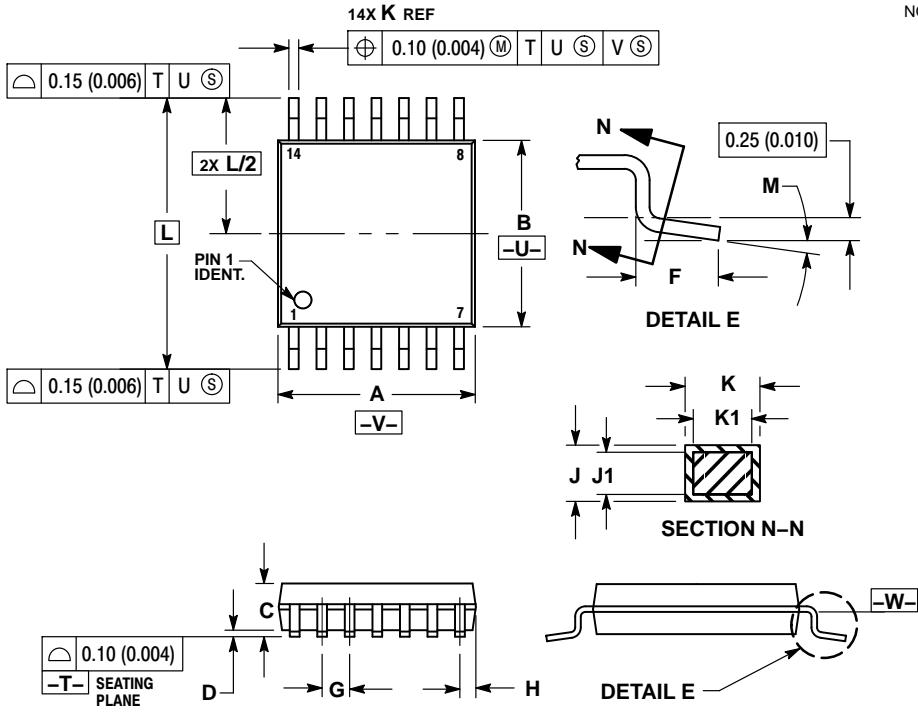
DIMENSIONS: MILLIMETERS

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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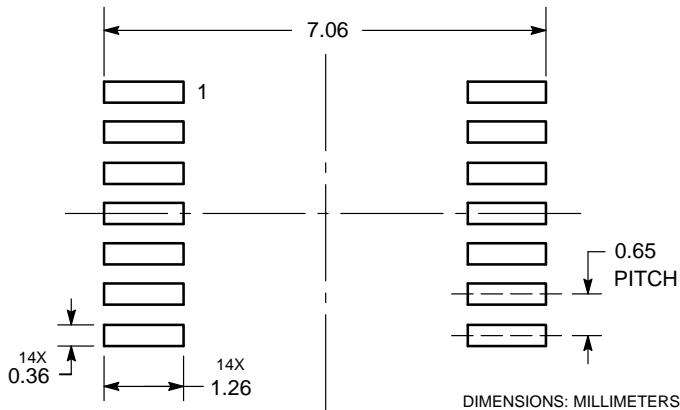
PACKAGE DIMENSIONS

TSSOP-14
CASE 948G
ISSUE B



DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	4.90	5.10	0.193	0.200
B	4.30	4.50	0.169	0.177
C	—	1.20	—	0.047
D	0.05	0.15	0.002	0.006
F	0.50	0.75	0.020	0.030
G	0.65 BSC	—	0.026 BSC	—
H	0.50	0.60	0.020	0.024
J	0.09	0.20	0.004	0.008
J1	0.09	0.16	0.004	0.006
K	0.19	0.30	0.007	0.012
K1	0.19	0.25	0.007	0.010
L	6.40 BSC	—	0.252 BSC	—
M	0°	8°	0°	8°

SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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[1003W-10/32-15](#) [LTILA6E-1S-WH-RC-FN12VXCR1](#) [0131700000](#) [00-2240](#) [LTP70N06](#) [LVP640](#) [0158-624-00](#) [5J0-1000LG-SIL](#) [020017-13](#)
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